

P-Channel 60 V (D-S) MOSFET

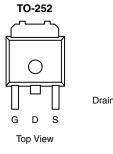
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ)			
- 60	0.053 at V _{GS} = - 10 V	- 25	26			
- 60	0.062 at V_{GS} = - 4.5 V	- 20	20			

FEATURES

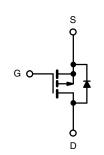
- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



Drain Connected to Tab



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise note)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 60	v			
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current (T_{I} = 150 °C)	T _C = 25 °C	I_	- 25			
$Commutous Drain Current (1) = 150^{\circ} C)$	T _C = 125 °C		- 20	•		
Pulsed Drain Current	I _{DM}	- 100	A			
Avalanche Current, Single Pulse	L = 0.1 mH	I _{AS}	- 22			
Repetitive Avalanche Energy, Single Pulse ^a	L = 0.1 mH	E _{AS}	24.2	mJ		
Dever Dissignation	T _C = 25 °C	P _D	38.5 ^c	- w		
Power Dissipation	T _A = 25 °C		2.3 ^{b, c}			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Martine and Archive b	t ≤ 10 s	R _{thJA}	17	21	°C/W	
Maximum Junction-to-Ambient ^b	Steady State		45	55		
Maximum Junction-to-Case		R _{thJC}	2.7	3.25		
Notes:						

a. Duty cycle \leq 1 %.

b. When mounted on 1" square PCB (FR-4 material).

c. See SOA curve for voltage derating.

d. Based up on $T_C = 25$ °C.



SPECIFICATIONS (T _J = 25 °C, unless otherwise note)							
Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V_{GS} = 0 V, I_D = - 250 μ A	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0$ V, $V_{GS} = \pm 20$ V			± 100	nA	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 150 $^{\circ}$ C			- 125	1	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 30			А	
		V _{GS} = - 10 V, I _D = - 10 A		0.053	0.060		
Drain Course On State Desistance	Base	V_{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C			0.102	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C			0.120		
		V _{GS} = - 4.5 V, I _D = - 5 A		0.062	0.070		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1140	1710	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		130			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge ^c	Qg			26	40		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -10$ A		4.5		nC	
Gate-Drain Charge ^c	Q _{gd}	1		7		1	
Gate Resistance	Rg	f = 1 MHz		7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, \text{ R}_{L} = 3 \Omega$		9	15		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 19 Å, V_{GEN} = - 10 V, R_g = 2.5 Ω		65	100	ns	
Fall Time ^c	t _f	1		30	45		
Drain-Source Body Diode and Characte	eristics $(T_c = 2)$	5 °C) ^b		1	1		
Continuous Current	I _S	,			- 30		
Pulsed Current	I _{SM}				- 30	A	
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

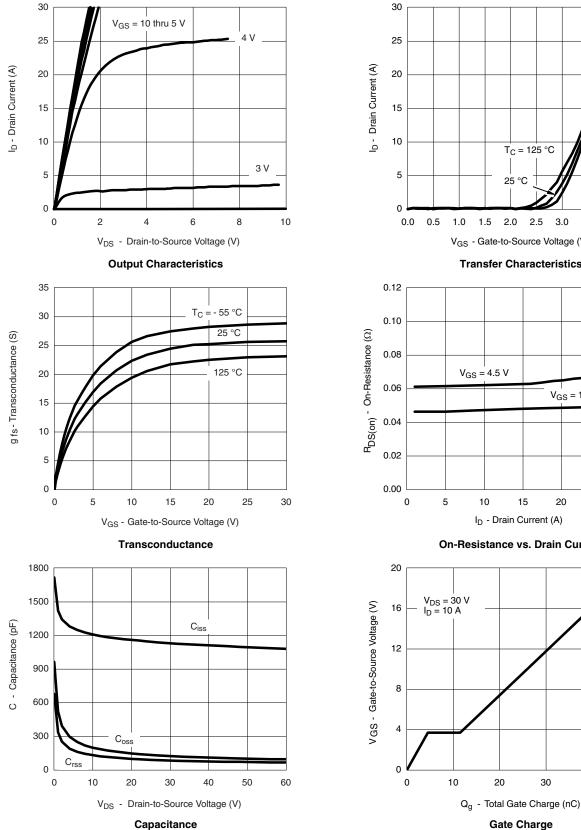
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

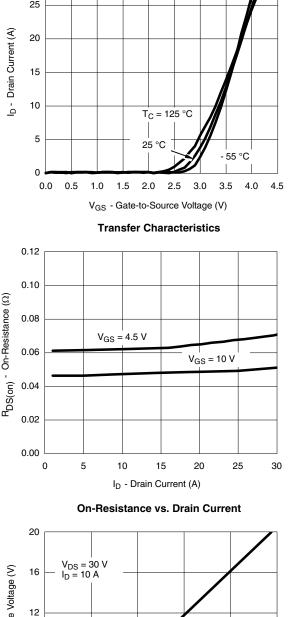
emi

ZXMP6A18KTC



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





20

Gate Charge

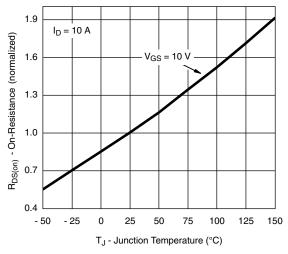
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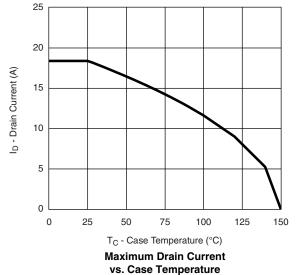


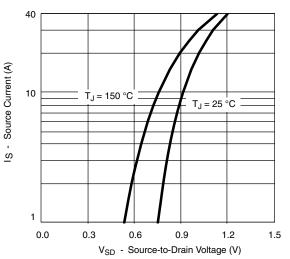
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



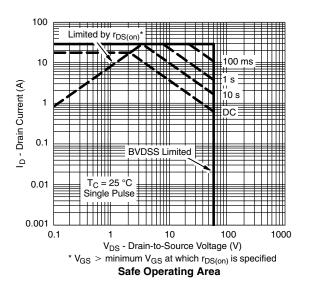
On-Resistance vs. Junction Temperature

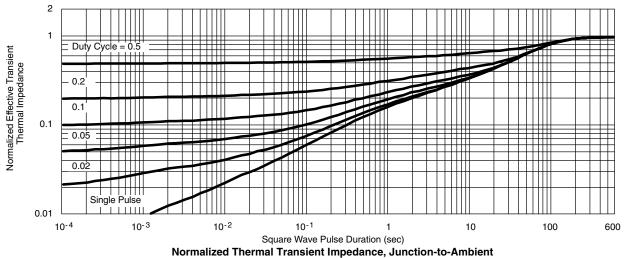






Source-Drain Diode Forward Voltage

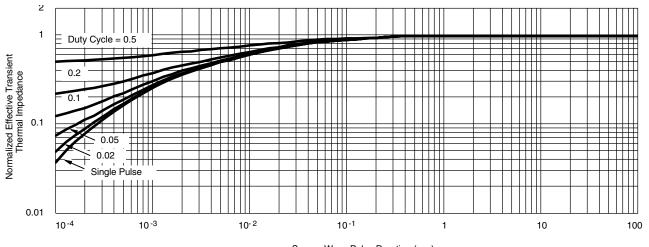








THERMAL RATINGS



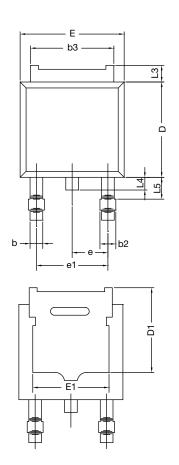
Square Wave Pulse Duration (sec)

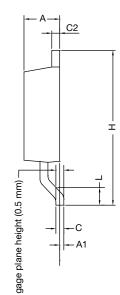
Normalized Thermal Transient Impedance, Junction-to-Case

ZXMP6A18KTC









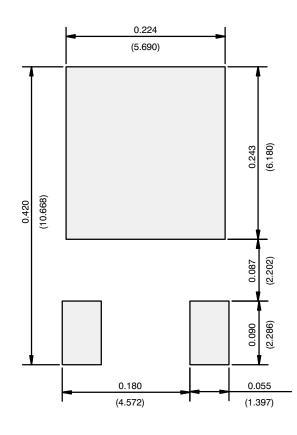
	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	2.28 BSC		BSC	
e1	4.56	4.56 BSC		BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16 DWG: 5347					

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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